

QUICKSWITCH® PRODUCTS HIGH-SPEED CMOS QUICKSWITCH 32:16 MUX/DEMUX

IDTQS3162233

FEATURES:

- Enhanced N channel FET with no inherent diode to Vcc
- Zero propagation delay, zero ground bounce
- TTL-compatible input and output levels
- Undershoot clamp diodes on all switch and control pins
- Available in 56-pin SSOP and TSSOP Packages

APPLICATIONS

- Video, audio, graphics switching, muxing
- Hot-swapping, hot-docking
- Voltage translation (5V to 3.3V)
- Bus funneling

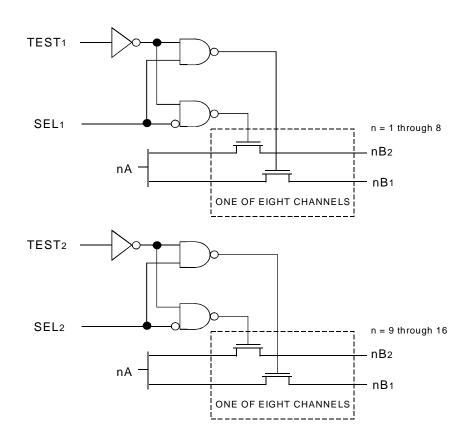
DESCRIPTION:

The QS3162233 is a 32-bit to 16-bit high-speed CMOS, TTL-compatible switch which can multiplex or demultiplex data. It can be used for memory interleaving where two memory banks need to be addressed simultaniously. It can also be used as two 16-bit to 8-bit multiplexers or as one 32-bit to 16-bit multiplexer. SELn inputs control the data flow. TESTn inputs control either one or two ports connection. The QS3162233 adds an internal 25 Ω series termination resistor to each switch to reduce reflection noise in high-speed applications.

Mux/Demux devices provide an order of magnitude faster speed than equivalent logic devices.

The QS3162233 is characterized for operation at -40°C to +85°C.

FUNCTIONAL BLOCK DIAGRAM

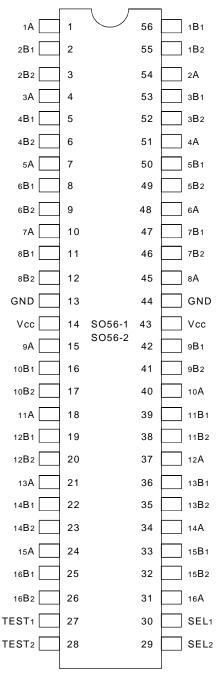


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INDUSTRIAL TEMPERATURE RANGE

NOVEMBER 2001

PIN CONFIGURATION



SSOP/ TSSOP TOP VIEW

PIN DESCRIPTION

Pin Names	I/O	Description
nA	I/O	Bus A
nB1, nB2	I/O	Bus B
SEL1, SEL2	I	Data Select
TEST1, TEST2	I	Port Select

ABSOLUTE MAXIMUM RATINGS (1)

Symbol	Description		Max.	Unit
VTERM ⁽²⁾	Supply Voltage to Ground		- 0.5 to +7	V
VTERM ⁽³⁾	DC Switch Voltage Vs		- 0.5 to +7	V
VTERM ⁽³⁾	DC Input Voltage V _{IN}		- 0.5 to +7	٧
VAC	AC Input Voltage (pulse width ≤20ns)		-3	٧
Іоит	DC Output Current		120	mA
Рмах	Maximum Power SSOP		.93	W
	Dissipation (TA = 85°C) TSSOP		.77	
Tstg	Storage Temperature		- 65 to +150	°C

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Vcc Terminals.
- 3. All terminals except Vcc.

CAPACITANCE

 $(TA = +25^{\circ}C, f = 1.0MHz, VIN = 0V, VOUT = 0V)$

Pins		Тур.	Max. (1)	Unit
Control Inputs		5	5.5	pF
Quickswitch Channels	Mux	8.5	10	pF
(Switch OFF)	Demux	6	7	pF

NOTE:

1. This parameter is guaranteed but not production tested.

FUNCTION TABLE(1)

n = 1 through 8

SEL ₁	TEST ₁	nA	Function
L	L	nB1	nA to nB1
Н	L	nB2	nA to nB2
Х	Н	nB1, nB2	nA to nB ₁ and nB ₂

n = 9through 16

SEL ₂	TEST ₂	nA	Function
L	L	nB1	nA to nB1
Н	L	nB ₂	nA to nB ₂
Х	Н	nB ₁ , nB ₂	nA to nB1 and nB2

NOTE:

H = HIGH Voltage Level
L = LOW Voltage Level

X = Don't Care

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

 $\label{lem:conditions} \textbf{Following Conditions Apply Unless Otherwise Specified:}$

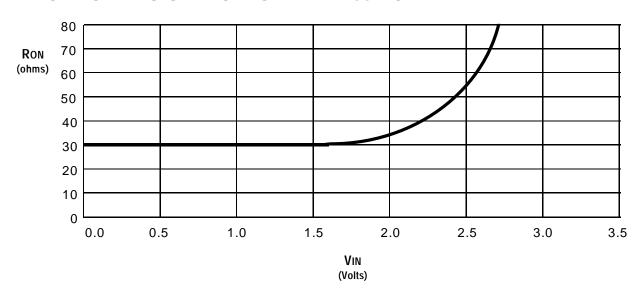
Industrial: $T_A = -40^{\circ}C$ to $+85^{\circ}C$, $V_{CC} = 5.0V \pm 10\%$

Symbol	Parameter	Test Conditions	Min.	Тур.(1)	Max.	Unit
VIH	Input HIGH Voltage	Guaranteed Logic HIGH for Control Pins	2	_		٧
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Pins	_	_	0.8	٧
lin	Input Leakage Current (Control Inputs)	0V ≤ VIN ≤ Vcc	_	_	±1	μΑ
loz	Off-State Current (Hi-Z)	0V ≤ Vout ≤ Vcc	_	_	±1	μΑ
Ron	Switch ON Resistance	Vcc = Min., VIN = 0V, ION = 30mA	22	30	45	Ω
Ron	Switch ON Resistance	Vcc = Min., Vin = 2.4V, Ion = 15mA	22	37	55	Ω
VP	Pass Voltage (2)	VIN = Vcc = 5V, IOUT = -5μA	3.7	4	4.2	V

NOTES:

- 1. Typical values are at Vcc = 5.0V, TA = 25°C.
- 2. Pass voltage is guaranteed but not production tested.

TYPICAL ON RESISTANCE vs Vin AT Vcc = 5V



POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾	Max.	Unit
Icco	Quiescent Power Supply Current	Vcc = Max., Vin = GND or Vcc, f = 0	3	μΑ
Δlcc	Power Supply Current per Control Input HIGH (2)	Vcc = Max., Vin = 3.4V, f = 0	3	mA
ICCD	Dynamic Power Supply Current per MHz ⁽³⁾	Vcc = Max., A and B pins open	0.25	mA/MHz
		Control Input Toggling at 50% Duty Cycle		

NOTES:

- 1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.
- 2. Per TLL driven input (VIN = 3.4V). A and B pins do not contribute to Δ Icc.
- 3. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C, V_{CC} = 5.0V \pm 10\%$

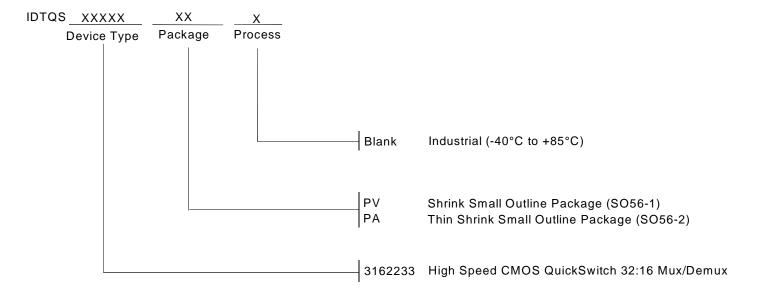
CLOAD = 50pF, RLOAD = 500Ω unless otherwise noted.

Symbol	Parameter	Min. ⁽¹⁾	Тур.	Max.	Unit
tplh	Data Propagation Delay (2,4)	_	_	1.25 ⁽³⁾	
tphl	nA to nBx, nBx to nA				ns
tBX	Switch Multiplex Delay	1 5	_	6.5	
	SEL to nA	1.5			ns
tpzl	Switch Turn-on Delay	1.5	_	6.5	
tpzh	SEL, TEST to nBx	1.5			ns
tplz	Switch Turn-off Delay (2)	1.5	_	5.8	
tphz	SEL, TEST to nBx	1.5			ns

NOTES:

- 1. Minimums are guaranteed but not production tested.
- 2. This parameter is guaranteed but not production tested.
- 3. The time constant for the switch alone is of the order of 1.25ns at CL = 50pF.
- 4. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

ORDERING INFORMATION





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